6A10

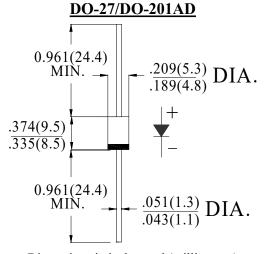
6.0AMPS . GLASS PASSIVATED RECTIFIERS

FEATURE

- . High current capability
- . Low forward voltage drop
- . Low power loss, high efficiency
- . High surge capability
- . High temperature soldering guaranteed 260°C /10sec/ 0.375" lead length at 5 lbs tension

MECHANICAL DATA

- . Terminal: Plated axial leads solderable per MIL-STD 202E, method 208C
- . Case: Molded with UL-94 Class V-0 recognized Flame Retardant Epoxy
- . Polarity: color band denotes cathode
- . Mounting position: any



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%

Type Number	SYM	6A 10	units	
	BOL			
Maximum Recurrent Peak Reverse Voltage	$V_{ m RRM}$	1000	V	
Maximum RMS Voltage	$V_{ m RMS}$	700	V	
Maximum DC Blocking Voltage	$V_{ m DC}$	1000	V	
Maximum Average Forward Rectified Current	$I_{ m F(AV)}$	6.0	A	
.375"(9.5mm) lead length				
Peak Forward Surge Current 8.3ms single				
half sine-wave superimposed on rated load	I_{FSM}	175.0	A	
(JEDEC method)				
Maximum Forward Voltage at 6.0A DC	$V_{ m F}$	1.1	V	
Maximum DC Reverse Current @Tj =25°C	7	5.0		
at rated DC blocking voltage @Tj =125°C	$I_{ m R}$	200	μΑ	
Typical Junction Capacitance (Note1)	$C_{ m J}$	100	pF	
Typical Thermal Resistance (Note2)	$R_{(JA)}$	55	°C/W	
Storage Temperature	TSTG	-55 to +150	°C	
Operation JunctionTemperature	$T_{ m J}$	-55 to +150	°C	

Note:

- 1. Measured at 1.0 MHz and applied reverse voltage of 4.0Vdc
- 2. Thermal Resistance from Junction to Ambient at 0.375"(9.5mm)lead length, vertical P.C.Board Mounted

RATING AND CHARACTERISTIC CURVES

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

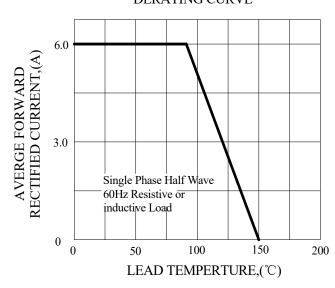


FIG.2-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

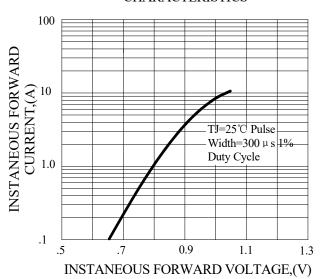


FIG.3-MAXIMUN NON-REPETITIVE FORWARD SURGE CURRENT

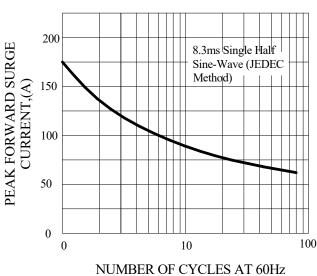
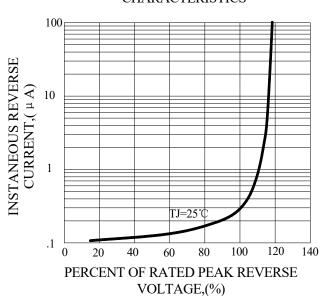
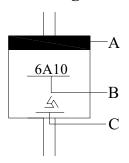


FIG.4-TYPICAL REVERSE CHARACTERISTICS



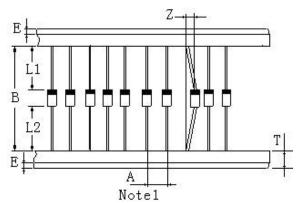
Marking and packaging illustration

1. Marking



SYMBOL	Explanation	
A	Color Band Denotes Cathode	
В	Product Name	
C	Trademark	

2. Packaging



ITEM	SYMBOL	SPECIFICATIONS	SPECIFICATIONS
		(mm)	(inch)
Component alignment	Z	1.2max	0.048max
Tape width	T	6.0±0.4	0.236±0.016
Exposed adhesive	Е	0.8max	0.032max
Body eccentricity	L1-L2	1.0max	0.040max
Component	A	10.0 ± 0.5	0.4 ± 0.02
Inner tap	В	52.0~53.5	2.05~2.11

NOTE:

Each component lead shall be sandwiched between tapes for a minimum of 2.5mm (0.1inch)